

July 7, 2021
SoftBank Group Corp.

Early Redemption of Domestic Hybrid Bonds
(with a Subordination Provision) Issued in 2016

SoftBank Group Corp. announced today that it will redeem all of its 1st and 3rd unsecured subordinated bonds with interest deferrable clause and early redeemable option (with a subordination provision) on September 16, 2021 and September 30, 2021, the respective first optional redemption dates. The details of the redemption are as follows.

Unsecured subordinated bonds with interest deferrable clause and early redeemable option (with a subordination provision)

	1st	3rd
1. Total amount of issue	JPY 55.6 billion	JPY 400.0 billion
2. Date of issue	September 16, 2016	September 30, 2016
3. Maturity date	September 13, 2041	September 30, 2041
4. Date of early redemption	September 16, 2021 (first optional redemption date)	September 30, 2021 (first optional redemption date)
5. Interest rate	3.00% per annum	3.00% per annum
6. Total amount of early redemption	JPY 55.6 billion	JPY 400.0 billion
7. Amount of early redemption	JPY 100 per each bond of JPY 100	